## 2.5/5.0/8.0Gbps PCIe Passive Switches


#### Abstract

General Description The MAX4889B/MAX4889C high-speed passive switches route PCI Express ${ }^{\circledR}$ (PCle) data between two possible destinations in desktop or notebook PCs. The MAX4889B/MAX4889C are quad double-pole/doublethrow ( $4 \times$ DPDT) switches ideal for switching four half lanes of PCle data between two destinations. The MAX4889B/MAX4889C feature a single digital control input (SEL) to switch signal paths. The MAX4889C is intended for use in systems (e.g., SAS) where both the input and output are capacitively coupled, and provides a $10 \mu \mathrm{~A}$ (typ) source current and a $60 \mathrm{k} \Omega$ (typ) internal biasing resistor to GND at the _OUT_ terminals. The MAX4889B/MAX4889C are fully specified to operate from a single +3.3 V (typ) power supply. Both devices are available in an industry-standard $3.5 \mathrm{~mm} \times$ $9.0 \mathrm{~mm}, 42-$ pin TQFN package. These devices operate over the $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ extended temperature range.


$\qquad$
Desktop PCs
Notebook PCs
Servers
Video Graphics Cards-SLI®
(Scaled Link Interface) and CrossFire ${ }^{\text {TM }}$

PCI Express is a registered service mark of PCI-SIG Corporation.
SLI is a registered trademark of NVIDIA Corporation.
CrossFire is a trademark of ATI Technologies, Inc.

- Single +3.3V Power-Supply Voltage
- Support PCle Gen I, Gen II, and Gen III Data Rates
- Supports SAS I, SAS II, and SAS 6.0Gbps (MAX4889C)
- Superior Return Loss

Better than -10 dB (typ) at 5.0 GHz

- Small 3.5mm x 9.0mm, 42-Pin TQFN Package
- Industry-Standard Pinouts

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE |
| :--- | :--- | :--- |
| MAX4889BETO + | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 42 TQFN-EP* |
| MAX4889CETO + | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 42 TQFN-EP |

+Denotes a lead(Pb)-free/RoHS-compliant package.
*EP = Exposed pad.

Typical Operating Circuit appears at end of data sheet.
Pin Configuration


## 2.5/5.0/8.0Gbps PCle Passive Switches

## ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND, unless otherwise noted.)

|  |  |
| :---: | :---: |
| SEL, _IN_, _OUTA_, _OUTB_ (Note 1). | -0.3V to ( $\left.\mathrm{V}_{\mathrm{CC}}+0.3 \mathrm{~V}\right)$ |
| Continuous Current (AIN_ to AOUTA」/AOUTB_, BIN_ to |  |
| BOUTA_/BOUTB_, CIN_ to COUTA_/COUTB_, DIN_ to |  |
| DOUTA_/DOUTB_) ................................................. $\pm 70 \mathrm{~mA}$ |  |
| Peak Current (AIN_ to AOUTA_/AOUTB_, BIN_ to |  |
| BOUTA_/BOUTB_, CIN_ to COUTA_COUTB_, DIN_ to |  |
| DOUTA_/DOUTB_) |  |
| (pulsed at 1ms, 10\% duty cycle).......................... $\pm 70 \mathrm{~mA}$ |  |
| Continuous Current (SEL)......................................... $\pm 10 \mathrm{~mA}$ |  |
| Peak Current (SEL) |  |
| (pulsed at 1ms, 10\% duty cycle) |  |

Continuous Power Dissipation $\left(\mathrm{T}_{\mathrm{A}}=+70^{\circ} \mathrm{C}\right)$ for multilayer board: 42-Pin TQFN (derate $35.7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ above $+70^{\circ} \mathrm{C}$ ) ....... 2857 mW
Operating Temperature Range ........................... $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Junction Temperature ..................................................... $+150^{\circ} \mathrm{C}$
Storage Temperature Range ............................. $65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$
Package Junction-to-Ambient Thermal Resistance ( $\theta_{\text {JA }}$ ) (Note 2)
Package Junction-to-Case Thermal Resistance ( $\theta$ Jc) (Note 2)
$28.0^{\circ} \mathrm{C} / \mathrm{W}$

Lead Temperature (soldering, 10s) $2.0^{\circ} \mathrm{C} / \mathrm{W}$
Lead Temperature (soldering, 10s) ............................................................... $260^{\circ} \mathrm{C}$
Soldering Temperature (reflow) $+260^{\circ} \mathrm{C}$

Note 1: Signals on SEL, _IN_, _OUTA_, _OUTB_ exceeding VCC or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.
Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to www.maxim-ic.com/thermal-tutorial.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## ELECTRICAL CHARACTERISTICS

$\left(\mathrm{V}_{C C}=+3.3 \mathrm{~V} \pm 10 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\right.$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. Typical values are at $\mathrm{V}_{\mathrm{CC}}=+3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$, unless otherwise noted.) (Note 3)

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DC PERFORMANCE |  |  |  |  |  |  |
| Analog Signal Range |  |  | -0.3 |  | $\begin{gathered} \mathrm{V}_{\mathrm{CC}}- \\ 1.8 \end{gathered}$ | V |
| On-Resistance | Ron | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=+3.0 \mathrm{~V}, \mathrm{I}_{2} \text { IN_ }=15 \mathrm{~mA}, \mathrm{~V}_{-} \text {OUTA_, } \\ & \mathrm{V}_{\text {_OUTB_ }}=0 \mathrm{~V}, 1.2 \mathrm{~V} \end{aligned}$ |  | 6.4 | 8.4 | $\Omega$ |
| On-Resistance Match Between Pairs of Same Channel | $\triangle \mathrm{RON}$ | $\mathrm{V}_{\mathrm{CC}}=+3.0 \mathrm{~V}, \mathrm{I}_{-} \mathrm{N}_{-}=15 \mathrm{~mA}, \mathrm{~V}_{\text {_OUTA_ }}$ V_OUTB_ = OV (Notes 4, 5) |  | 0.1 | 0.5 | $\Omega$ |
| On-Resistance Match Between Channels | $\triangle \mathrm{RON}$ | VCC $=+3.0 \mathrm{~V}, \mathrm{I}_{-} \mathrm{N}_{-}=15 \mathrm{~mA}$, V_OUTA, <br> V_OUTB_ = OV (Notes 4, 5) |  | 0.2 |  | $\Omega$ |
| On-Resistance Flatness | RFLAT (ON) | $\mathrm{V}_{\mathrm{CC}}=+3.0 \mathrm{~V}, I_{\text {IIN_ }}=15 \mathrm{~mA}, \mathrm{~V}_{-} \text {OUTA_, }$ <br> V_outb_ = OV, 1.2V (Notes 5, 6) |  | 0.3 |  | $\Omega$ |
| _OUTA_ or _OUTB_ Off-Leakage Current | I_OUTA_ (OFF), I_OUTB_ (OFF) | VCC $=+3.6 \mathrm{~V}, \mathrm{~V}_{-} I \mathrm{~N}_{-}=0 \mathrm{~V}, 1.2 \mathrm{~V}, \mathrm{~V}$ _OUTA_ or V_OUTB_ = 1.2V, OV (MAX4889B) | -1 |  | +1 | $\mu \mathrm{A}$ |
| _IN_ On-Leakage Current | I_IN_ (ON) | $\mathrm{V}_{\mathrm{CC}}=+3.6 \mathrm{~V}, \mathrm{~V}_{-} I \mathrm{~N}_{-}=0 \mathrm{~V}, 1.2 \mathrm{~V}, \mathrm{~V}_{-}$OUTA_ or V_OUTB_ = V_IN_ or unconnected (MAX4889B) | -1 |  | +1 | $\mu \mathrm{A}$ |
| Output Short-Circuit Current |  | All other ports are unconnected (MAX4889C) | 5 |  | 15 | $\mu \mathrm{A}$ |
| Output Open-Circuit Voltage |  | All other ports are unconnected (MAX4889C) | 0.2 | 0.6 | 0.9 | V |

## 2．5／5．0／8．0Gbps PCIe Passive Switches

## ELECTRICAL CHARACTERISTICS（continued）

$\left(\mathrm{V}_{C C}=+3.3 \mathrm{~V} \pm 10 \%, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}\right.$ to $\mathrm{T}_{\mathrm{MAX}}$ ，unless otherwise noted．Typical values are at $\mathrm{V}_{\mathrm{CC}}=+3.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ ，unless otherwise noted．）（Note 3）

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| AC PERFORMANCE |  |  |  |  |  |  |
| SEL－to－Switch Turn－On Time | ton＿SEL | $Z_{S}=Z_{L}=50 \Omega$ |  | 80 |  | ns |
| SEL－to－Switch Turn－Off Time | toff＿SEL | $Z_{S}=Z_{L}=50 \Omega$ ，Figure 1 |  | 15 |  | ns |
| Propagation Delay | tpD | $Z_{S}=Z_{L}=50 \Omega$ ，Figure 2 |  | 50 |  | ps |
| Output Skew Between Pairs | tSKEW1 | $Z_{S}=Z_{L}=50 \Omega$ ，Figure 2 |  | 50 |  | ps |
| Output Skew Between Same Pair | tSKEW2 | $Z_{S}=Z_{L}=50 \Omega$ ，Figure 2 |  | 10 |  | ps |
| Differential Return Loss（Note 5） | SDD11 | $\mathrm{OHz}<\mathrm{f} \leq 2.8 \mathrm{GHz}$ | －14 |  |  | dB |
|  |  | $2.8 \mathrm{GHz}<\mathrm{f} \leq 5.0 \mathrm{GHz}$ | －8 |  |  |  |
|  |  | $\mathrm{f}>5.0 \mathrm{GHz}$ | －3 |  |  |  |
| Differential Insertion Loss（Note 5） | SDD21 | See Table 1 |  |  |  | dB |
| Differential Crosstalk（Note 5） | SDDCTK | $0 \mathrm{~Hz}<\mathrm{f} \leq 2.5 \mathrm{GHz}$ |  | －40 |  | dB |
|  |  | $2.5 \mathrm{GHz}<\mathrm{f} \leq 5.0 \mathrm{GHz}$ |  | －30 |  |  |
|  |  | $\mathrm{f}>5.0 \mathrm{GHz}$ |  | －25 |  |  |
| Differential Off－Isolation（Note 5） | SDD21＿OFF | $0 \mathrm{~Hz}<\mathrm{f} \leq 2.5 \mathrm{GHz}$ |  | －15 |  | dB |
|  |  | $2.5 \mathrm{GHz}<\mathrm{f} \leq 5.0 \mathrm{GHz}$ |  | －12 |  |  |
|  |  | $\mathrm{f}>5.0 \mathrm{GHz}$ |  | －12 |  |  |
| CONTROL INPUT（SEL） |  |  |  |  |  |  |
| Input Logic High | $\mathrm{V}_{\mathrm{IH}}$ |  | 1.4 |  |  | V |
| Input Logic Low | $\mathrm{V}_{\text {IL }}$ |  |  |  | 0.6 | V |
| Input Logic Hysteresis | $\mathrm{V}_{\mathrm{HYST}}$ |  |  | 130 |  | mV |
| POWER SUPPLY |  |  |  |  |  |  |
| Power－Supply Range | VCC |  | 3.0 |  | 3.6 | V |
| VCC Supply Current | IcC | $\mathrm{V}_{\text {SEL }}=0 \mathrm{~V}$ or $\mathrm{V}_{\text {CC }}$ |  |  | 1 | mA |

Note 3：All units are $100 \%$ production tested at $\mathrm{T}_{\mathrm{A}}=+85^{\circ} \mathrm{C}$ ．Limits over the operating temperature range are guaranteed by design and characterization and are not production tested．
Note 4：$\triangle$ RON $=$ RON（MAX）- RON（MIN）．
Note 5：Guaranteed by design，not production tested．
Note 6：Flatness is defined as the difference between the maximum and minimum value of on－resistance as measured over the specified analog signal range．

Table 1．Insertion Loss Mask

| FREQUENCY RANGE <br> （GHz） | MAXIMUM INSERTION <br> LOSS（dB） |
| :---: | :---: |
| $0-2.5$ | $\frac{14}{25} \times \mathrm{fGHz}^{2}+0.6$ |
| $2.5-5$ | $\frac{6}{5} \times \mathrm{fGHz}^{-1.0}$ |
| 5 or greater | $\frac{8}{5} \times \mathrm{fGHz}-3.0$ |

## 2.5/5.0/8.0Gbps PCIe Passive Switches



Figure 1. Switching Time

## 2.5/5.0/8.0Gbps PCle Passive Switches



Figure 2. Propagation Delay and Output Skew

## 2.5/5.0/8.0Gbps PCIe Passive Switches



DIFFERENTIAL RETURN LOSS
vs. FREQUENCY


## 2.5/5.0/8.0Gbps PCIe Passive Switches

Functional Diagram/Truth Table


0688tXVW/g688tXVW

## 2.5/5.0/8.0Gbps PCle Passive Switches

Pin Description

| PIN |  | FUNCTION |
| :---: | :---: | :---: |
| MAX4889B/ <br> MAX4889C | NAME |  |
| 1 | AIN+ | Analog Switch 1. Common Positive Terminal. |
| 2 | AIN- | Analog Switch 1. Common Negative Terminal. |
| 3 | AOUTB+ | Analog Switch 1. Normally Open Positive Terminal. |
| 4 | AOUTB- | Analog Switch 1. Normally Open Negative Terminal. |
| 5 | $\mathrm{BIN}+$ | Analog Switch 2. Common Positive Terminal. |
| 6 | BIN- | Analog Switch 2. Common Negative Terminal. |
| 7 | BOUTB+ | Analog Switch 2. Normally Open Positive Terminal. |
| 8 | BOUTB- | Analog Switch 2. Normally Open Negative Terminal. |
| $\begin{gathered} 9,19,21,26,31, \\ 34,39,41 \end{gathered}$ | Vcc | Positive Supply Voltage Input. Connect $\mathrm{V}_{\mathrm{Cc}}$ to a 3.0 V to 3.6 V supply voltage. Bypass $\mathrm{V}_{\mathrm{Cc}}$ to GND with a $0.1 \mu \mathrm{~F}$ ceramic capacitor placed as close as possible to the device. See the Board Layout section. |
| 10 | $\mathrm{ClN+}$ | Analog Switch 3. Common Positive Terminal. |
| 11 | CIN- | Analog Switch 3. Common Negative Terminal. |
| 12 | COUTB+ | Analog Switch 3. Normally Open Positive Terminal. |
| 13 | COUTB- | Analog Switch 3. Normally Open Negative Terminal. |
| 14 | DIN+ | Analog Switch 4. Common Positive Terminal. |
| 15 | DIN- | Analog Switch 4. Common Negative Terminal. |
| 16 | DOUTB+ | Analog Switch 4. Normally Open Positive Terminal. |
| 17 | DOUTB- | Analog Switch 4. Normally Open Negative Terminal. |
| $\begin{gathered} 18,20,22,25,29, \\ 35,38,40,42 \end{gathered}$ | GND | Ground |
| 23 | DOUTA- | Analog Switch 4. Normally Closed Negative Terminal. |
| 24 | DOUTA+ | Analog Switch 4. Normally Closed Positive Terminal. |
| 27 | COUTA- | Analog Switch 3. Normally Closed Negative Terminal. |
| 28 | COUTA+ | Analog Switch 3. Normally Closed Positive Terminal. |
| 30 | SEL | Control Signal Input. SEL has a 70k (typ) pulldown resistor to GND. |
| 32 | BOUTA - | Analog Switch 2. Normally Closed Negative Terminal. |
| 33 | BOUTA+ | Analog Switch 2. Normally Closed Positive Terminal. |
| 36 | AOUTA- | Analog Switch 1. Normally Closed Negative Terminal. |
| 37 | AOUTA+ | Analog Switch 1. Normally Closed Positive Terminal. |
| - | EP | Exposed Pad. Connect EP to GND. |

## 2.5/5.0/8.0Gbps PCIe Passive Switches

## Detailed Description

The MAX4889B high-speed passive switch routes PCI Express (PCle) data or other high-speed signals with amplitude of $\leq 1.2 \mathrm{VP}$-P differential, and common-mode voltage close to OV between two possible destinations. The MAX4889B is ideal for routing PCle signals to change system configuration. For example, in a graphics application, four MAX4889B devices create two sets of eight lanes from a single 16-lane bus. The MAX4889C feature a $10 \mu \mathrm{~A}$ (typ) source current and a $60 \mathrm{k} \Omega$ (typ) internal biasing resistor to GND at the _OUT_ terminals. The MAX4889C is ideal for dual capacitively coupled applications such as SAS and SATA. The MAX4889B/ MAX4889C feature a single digital control input (SEL) to switch signal paths. SEL has a $70 \mathrm{k} \Omega$ (typ) pulldown resistor to GND.
The MAX4889B/MAX4889C are fully specified to operate from a single 3.0 V to 3.6 V power supply.

Digital Control Input (SEL)
The MAX4889B/MAX4889C provide a single digital control input (SEL) to select the signal path between the _IN_ and _OUT_ channels. The truth tables for the MAX4889B/MAX4889C are illustrated in the Functional Diagram/Truth Table. SEL has a 70k $\Omega$ (typ) pulldown resistor to GND.

## Analog Signal Levels

The MAX4889B/MAX4889C accept standard PCle signals to a maximum of (VCC -1.8 V ). Signals on the _IN+ channels are routed to either the _OUTA+ or _OUTB+ channels. Signals on the _IN- channels are routed to either the _OUTA- or _OUTB- channels. The MAX4889B/MAX4889C are bidirectional switches, allowing _IN_ and _OUT_ to be used as either inputs or outputs.

## Applications Information

PCIe Switching
The MAX4889B/MAX4889C primary applications are aimed at reallocating PCIe lanes (see the Typical Operating Circuit: Video Graphics Cards). For example, in graphics applications, several manufacturers have found that it is possible to improve performance by a factor of nearly two by splitting a single 16-lane PCle bus into two 8-lane buses. Two of the more prominent examples are SLI (Scaled Link Interface) and CrossFire. Four MAX4889Bs permit a computer motherboard to operate properly with a single 16-lane graphics card, which can later be upgraded to dual cards.

Board Layout
High-speed switches require proper layout and design procedures for optimum performance. Keep controlledimpedance PCB traces as short as possible or follow impedance layouts per the PCle specification. Ensure that power-supply bypass capacitors are placed as close as possible to the device. Multiple bypass capacitors are recommended. Connect all grounds and the exposed pad to large ground planes.

## 2.5/5.0/8.0Gbps PCIe Passive Switches



## 2.5/5.0/8.0Gbps PCIe Passive Switches

Chip Information
PROCESS: CMOS

Package Information
For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "\#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

| PACKAGE <br> TYPE | PACKAGE <br> CODE | OUTLINE <br> NO. | LAND <br> PATTERN NO. |
| :---: | :---: | :---: | :---: |
| 42 TQFN | $\mathrm{T} 423590 \mathrm{M}+1$ | $\underline{\underline{21-0181}}$ | $\underline{\mathbf{9 0 - 0 0 7 9}}$ |

## 2.5/5.0/8.0Gbps PCle Passive Switches

| REVISION <br> NUMBER | REVISION <br> DATE | DESCRIPTION | PAGES <br> CHANGED |
| :---: | :---: | :--- | :---: | :---: |
| 2 | $8 / 10$ | Added 8.0Gbps PCle passive switch to the title; added Gen III to the data rates in the <br> Features section; changed the return loss in the Features section to $-10 \mathrm{~dB}(\mathrm{typ})$ at <br> 5.0 GHz | All |

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